# SML75HB06

Attributes:
-aerospace build standard
-high reliability
-lightweight
-metal matrix base plate
-AlN isolation

## Maximum rated values/ Electrical Properties

| | | | | |
|---|---|---|---|---|
| Collector-emitter Voltage | | $V_{ces}$ | 600 | V |
| DC Collector Current | Tc=75C<br>Tc=25C | $I_c$, nom<br>Ic | 75<br>100 | A |
| Repetitive peak Collector Current | tp=1msec,Tc=75C | $I_{crm}$ | 150 | A |
| Total PowerDissipation | Tc=25C | $P_{tot}$ | 260 | W |
| Gate-emitter peak voltage | | $V_{ges}$ | +/-20 | V |
| DC Forward Diode Current | | $I_f$ | 75 | A |
| Repetitive Peak Forward Current | tp=1msec | $I_{frm}$ | 150 | A |
| $I^2t$ value per diode | Vr=0V, tp=10msec, Tvj=125C | $I^2_t$ | 500 | $A^2sec$ |
| Isolation test voltage | RMS, 50Hz, t=1min | $V_{isol}$ | 2500 | V |

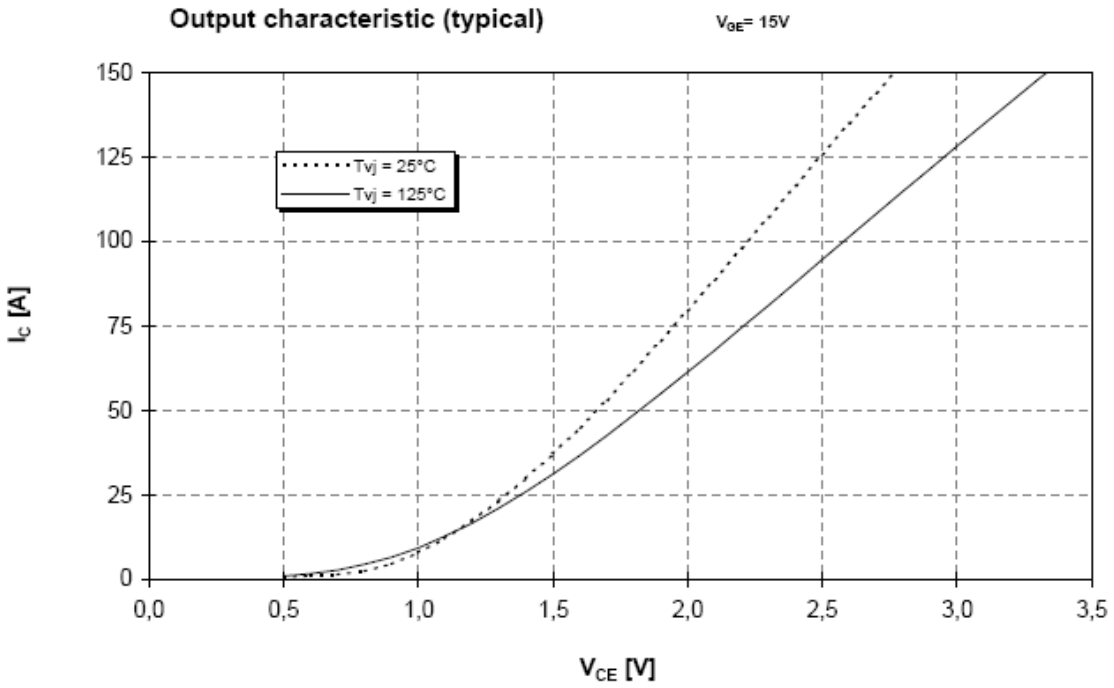
| | | | | | | |
|---|---|---|---|---|---|---|
| Collector-emitter saturation voltage | Ic=75A,Vge=15V, Tc=25C<br>Ic=75A,Vge=15V,Tc=125C | $V_{ce(sat)}$ | | 1.95<br>2.2 | 2.45 | V |
| Gate Threshold voltage | Vce=Vge, Tvj=25C | $Vge_{(th)}$ | 4.5 | 5.5 | 6.5 | V |
| Input capacitance | f=1MHz,Tvj=25C,Vce=25V, Vge=0V | $C_{ies}$ | | 3.2 | | nF |
| Reverse transfer Capacitance | f=1MHz,Tvj=25C,Vce=25V, Vge=0V | $C_{res}$ | | 0.3 | | nF |
| Collector emitter cut off current | Vce=600V,Vge=0V,Tvj=25C<br>Vce=600V,Vge=0V,Tvj=125C | $I_{ces}$ | | 1<br>1 | 500 | µA |
| Gate emitter cut off current | Vce=0V,Vge=20V,Tvj=25C | $I_{ges}$ | | | 400 | µA |

| | | | | | | |
|---|---|---|---|---|---|---|
| Turn on delay time | Ic=75A, Vcc=300V<br>Vge=+/15V,Rg=3Ω,Tvj=25C<br>Vge=+/-15V,Rg=3Ω,Tvj=125C | $t_{d,on}$ | | 63<br>65 | | nsec<br>nsec |
| Rise time | Ic=75A, Vcc=300V<br>Vge=+/-15V,Rg=3Ω,Tvj=25C<br>Vge=+/-15V,Rg=3Ω,Tvj=125C | tr | | 22<br>1025 | | nsec<br>nsec |
| Turn off delay time | Ic=75A, Vcc=300V<br>Vge=+/-15V,Rg=3Ω,Tvj=25C<br>Vge=+/-15V,Rg=3Ω,Tvj=125C | $t_{d,off}$ | | 155<br>170 | | nsec<br>nsec |
| Fall time | Ic=75A, Vcc=300V<br>Vge=+/-15V,Rg=3Ω,Tvj=25C<br>Vge=+/-15V,Rg=3Ω,Tvj=125C | $t_f$ | | 20<br>35 | | nsec<br>nsec |
| Turn energy loss per pulse | Ic=75A,Vce=300V,Vge=15V<br>Rge=2.7Ω,Tvj=125C,L=35nH | $E_{on}$ | | 0.7 | | mJ |
| Turn off energy loss per pulse | Ic=75A,Vce=300V, Vge=15V<br>Rge=Ω,Tvj=125C,L=30nH | $E_{off}$ | | 2.4 | | mJ |
| SC Data | tp≤10µsec, Vge≤15V<br>Tvj≤125C,Vcc=360V,Vce(max)-Vces-Lσdi/dT | $I_{sc}$ | | 340 | | A |
| Stray Module inductance | | $L_{σce}$ | | 40 | | nH |
| Terminal-chip resistance | | $R_c$ | | 1.2 | | mΩ |

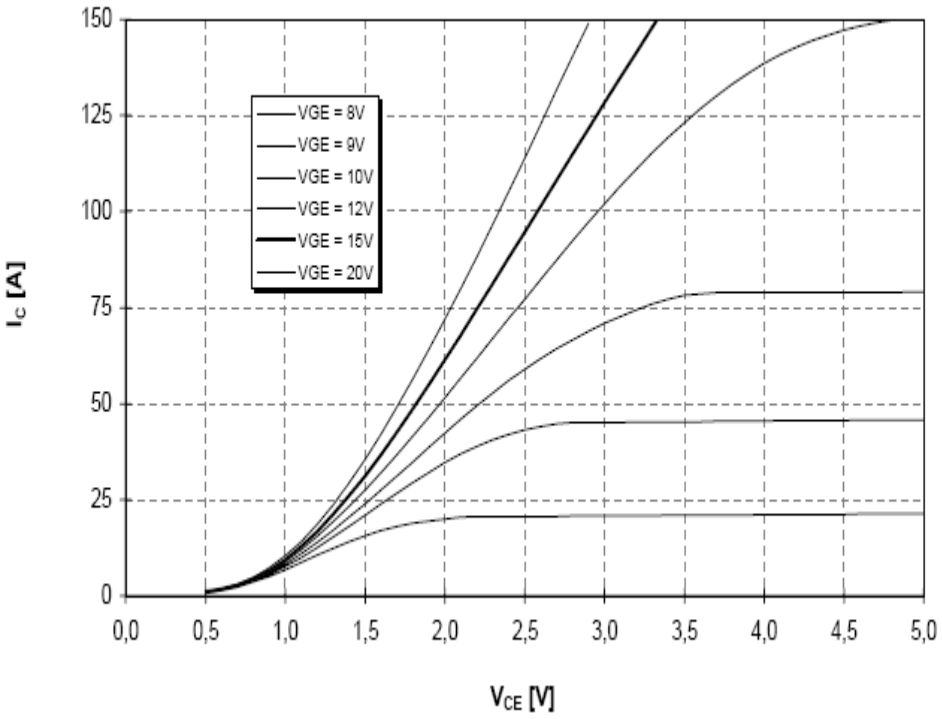
## Diode characteristics

| | | | | | | |
|---|---|---|---|---|---|---|
| Forward voltage | Ic=75A,Vge=0V, Tc=25C<br>Ic=75A,Vge=0V, Tc=125C | $V_f$ | | 1.25<br>1.2 | 1.6 | V |
| Peak reverse recovery current | If=75A, -di/dt=3000A/µsec<br>Vce=300V,Vge=-10V,Tvj=25C<br>Vce=300V,Vge=-10V,Tvj=125C | $I_{rm}$ | | 95<br>115 | | A |
| Recovered charge | If=75A, -di/dt=3000A/µsec<br>Vce=600V,Vge=-10V,Tvj=25C<br>Vce=600V,Vge=-10V,Tvj=125C | $Q_r$ | | 5.1<br>7.9 | | µC |
| Reverse recovery energy | If=75A, -di/dt=3000A/µsec<br>Vce=600V,Vge=-10V,Tvj=25C<br>Vce=600V,Vge=-10V,Tvj=125C | $E_{rec}$ | | .<br>2.3 | | mJ<br>mJ |

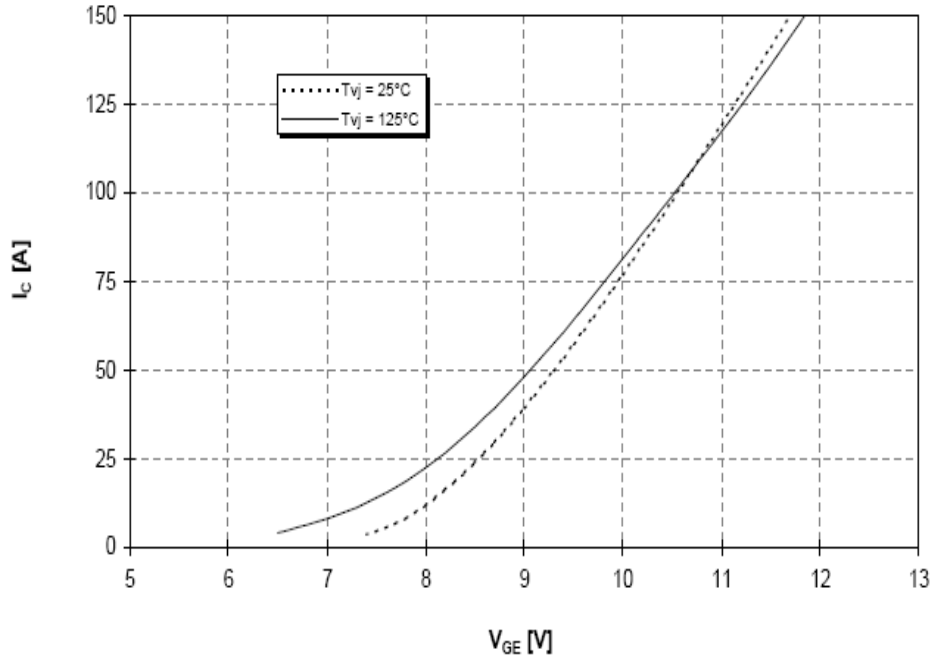
| Thermal Properties | | | Min | Typ | Max | |
|---|---|---|---|---|---|---|
| Thermal resistance junction to case | Igbt<br>Diode | $R_{\theta J-C}$ | | | 0.48<br>0.89 | K/W |
| Thermal resistance case to heatsink | | $R_{\theta C-hs}$ | | 0.03 | | K/W |
| Maximum junction temperature | | $T_{vj}$ | | | 150 | C |
| Maximum operating temperature | | $T_{op}$ | -55 | | 125 | C |
| Storage Temperature | | $T_{stg}$ | -55 | | 125 | C |



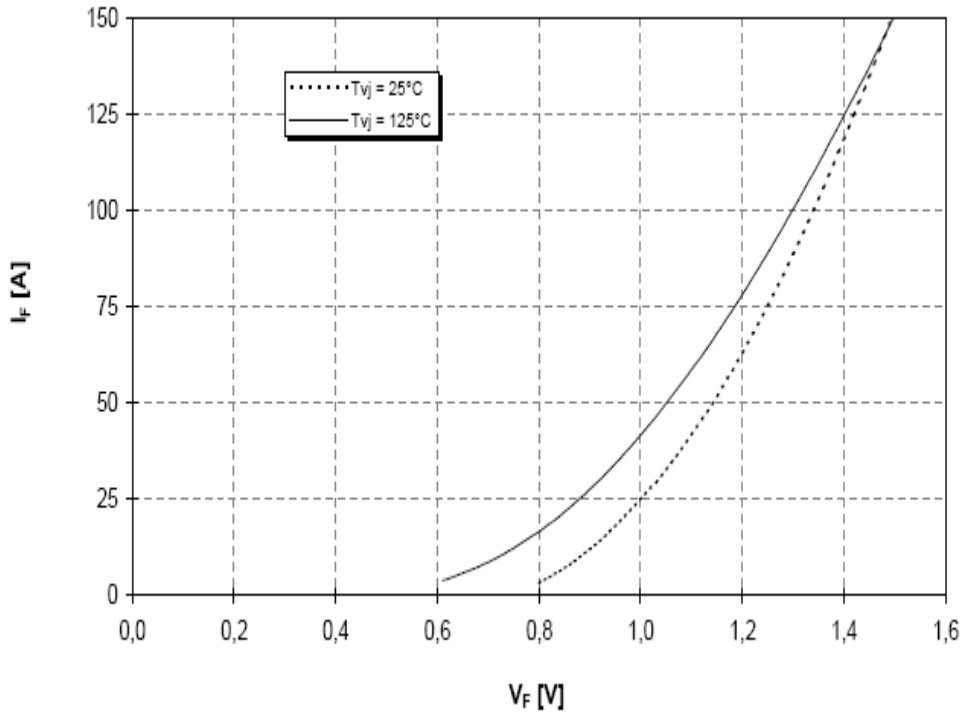
**Output characteristic (typical)** $T_{vj}$= 125°C



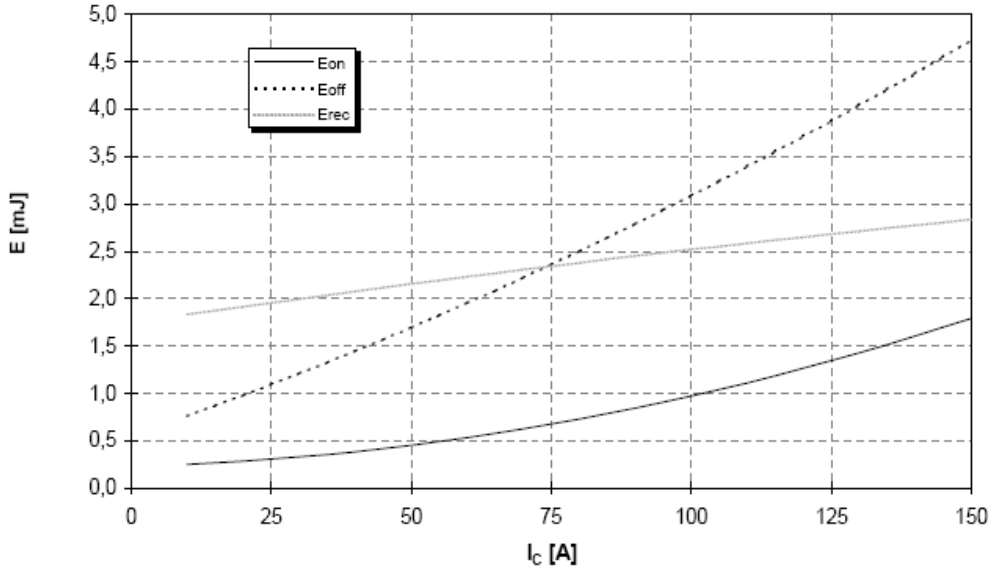

**Transfer characteristic (typical)** $V_{CE}$= 20V



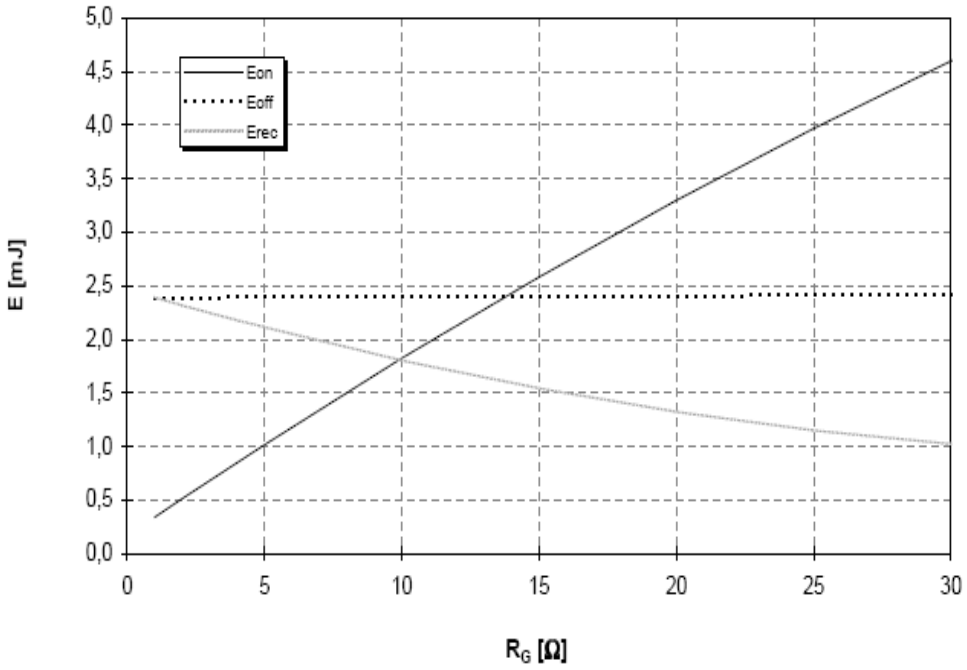
**Forward characteristic of inverse diode (typical)**



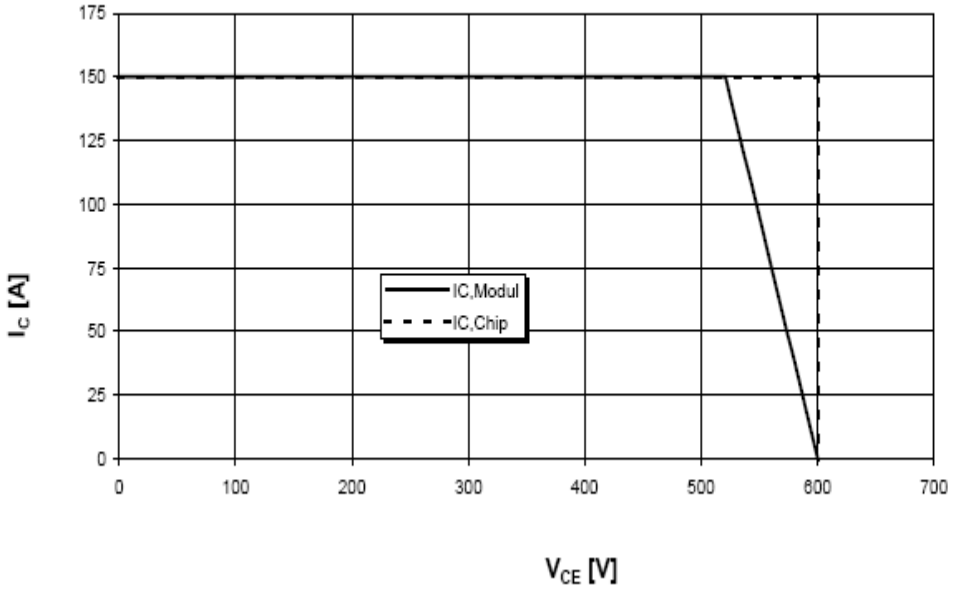

**Switching losses (typical)** $R_{G,on}$= 3,0Ω, $R_{G,off}$= 3,0Ω, $V_{CC}$= 300V, $T_{vj}$= 125°C



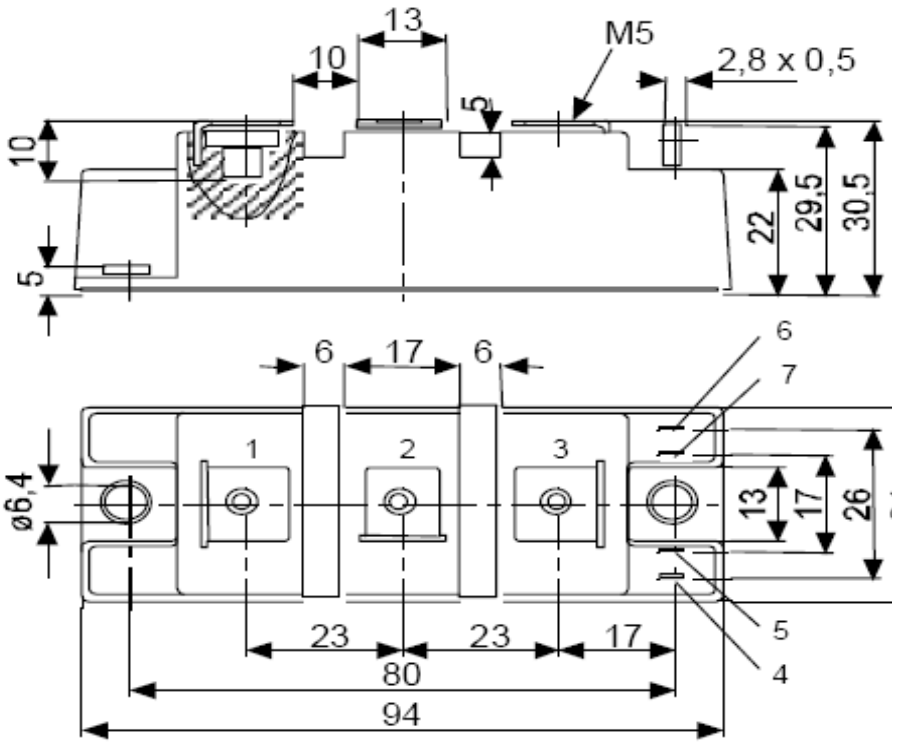
**Switching losses (typical)** $I_C$= 75A , $V_{CC}$= 300V , $T_{vj}$ = 125°C

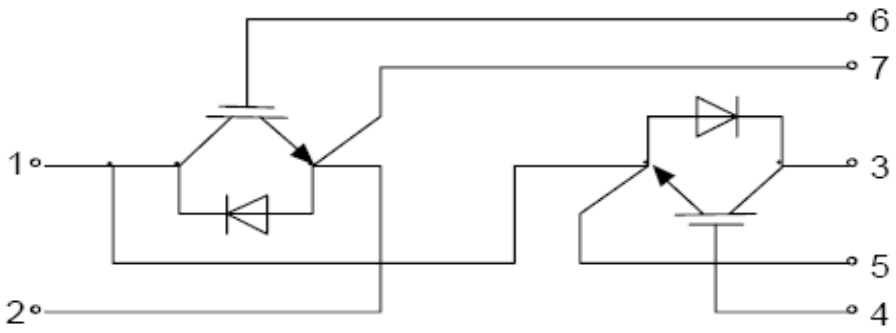



**Reverse bias safe operation area (RBSOA)** $V_{GE}$= +15V, $R_{G,off}$= 3,0Ω, $T_{vj}$= 125°C



## Package outline / Circuit diagram




CIRCUIT DIAGRAM